

### 30V Single P-Channel Enhancement-Mode MOSFET

General Description	Product Summary	
• Low gate charge.	$\bullet$ $BV_{DSS}$	-30V
• Use as a load switch.	$\bullet$ $R_{DS(on)}$ @ $VGS = -10V$	< 25mΩ
• Use in PWM applications	$\bullet$ $R_{DS(on)}$ @ $VGS = -4.5V$	< 38mΩ



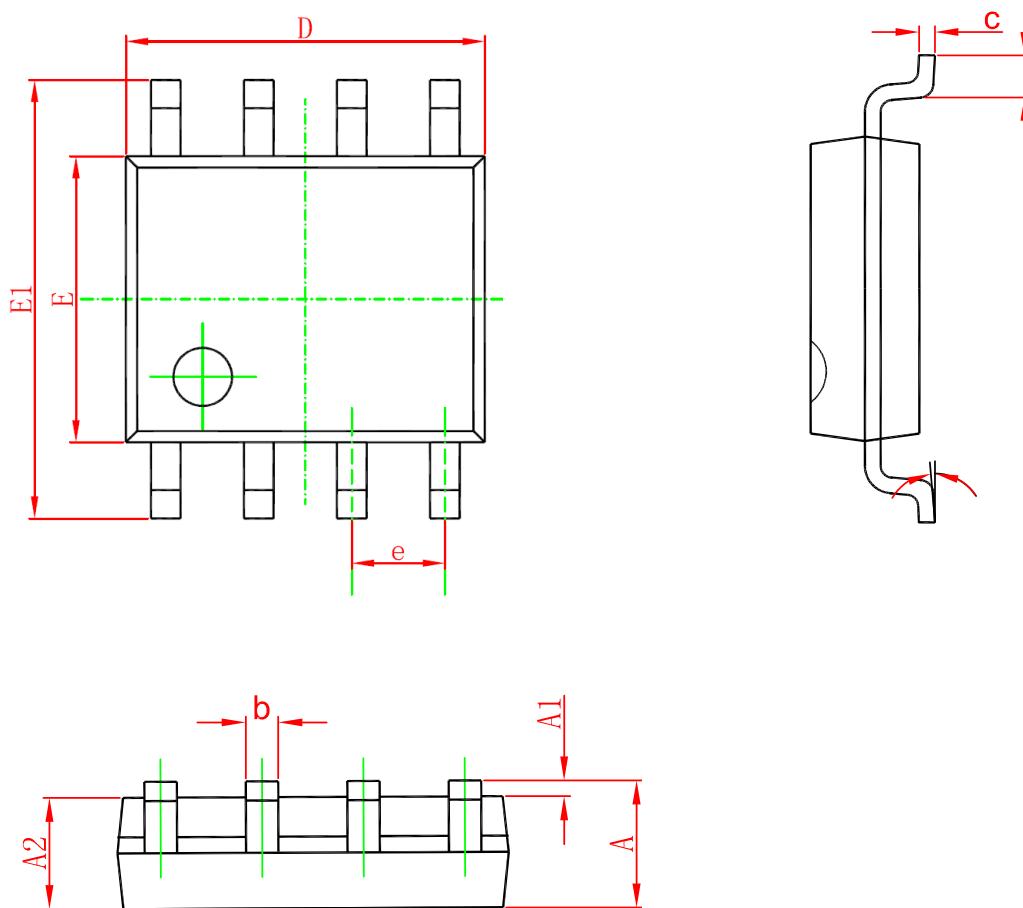
Absolute Maximum Ratings ( $T_A = 25^\circ C$ unless otherwise noted)				
Parameter	Symbol	Maximum	Units	
Drain-Source Voltage	$V_{DS}$	-30	V	
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V	
Drain Current ( $T_A=25^\circ C$ )	$I_D$	-9	A	
Drain Current ( $T_A=75^\circ C$ )		-7	A	
Pulsed Drain Current <sup>a</sup>	$I_{DM}$	-60	A	
Avalanche Energy ( $L = 0.1 \text{ mH}$ )	$E_{AS}$	25	mJ	
Power Dissipation <sup>b</sup> ( $T_A=25^\circ C$ )	$P_D$	2.5	W	
Power Dissipation <sup>b</sup> ( $T_A=75^\circ C$ )		1.8	W	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 ~ +150	°C	

Thermal Characteristics				
Parameter	Symbol	Maximum	Units	
Junction-to-Ambient <sup>a</sup> ( $t \leq 10s$ )	$R_{\theta JA}$	50	°C/W	
Junction-to-Ambient <sup>a,d</sup> (Steady-State)		90	°C/W	
Junction-to-Lead (Steady-State)	$R_{\theta JL}$	25	°C/W	

<b>Electrical Characteristics (<math>T_A = 25^\circ\text{C}</math> unless otherwise noted)</b>						
<b>Symbol</b>	<b>Parameter</b>	<b>Conditions</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Units</b>
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0\text{V}$ , $I_D = -250\mu\text{A}$	-30			V
$\text{I}_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}} = -30\text{V}$ , $V_{\text{GS}} = 0\text{V}$			-1	$\mu\text{A}$
$\text{I}_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}} = \pm 25\text{V}$ , $V_{\text{DS}} = 0\text{V}$			$\pm 100$	nA
<b>On Characteristics</b>						
$\text{V}_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}$ , $I_D = -250\mu\text{A}$	-1		-3.0	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance	$V_{\text{GS}} = -10\text{V}$ , $I_D = -9\text{A}$		18	25	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}$ , $I_D = -6.5\text{A}$		30	38	$\text{m}\Omega$
$\text{g}_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}} = -10\text{V}$ , $I_D = -9\text{A}$		24		S
<b>Drain-Source Diode Characteristics</b>						
$\text{V}_{\text{SD}}$	Diode Forward Voltage	$V_{\text{GS}} = 0\text{V}$ , $I_S = -1.0\text{A}$			-1.2	V
$\text{I}_S$	Maximum Body-Diode Continuous Current				-3.0	A
<b>Dynamic Characteristics</b>						
$\text{C}_{\text{iss}}$	Input Capacitance	$V_{\text{DS}} = -15\text{V}$ , $V_{\text{GS}} = 0\text{V}$ $f = 1.0\text{MHz}$		1490		pF
$\text{C}_{\text{oss}}$	Output Capacitance			301		pF
$\text{C}_{\text{rss}}$	Reverse Transfer Capacitance			190		pF
<b>Switching Characteristics</b>						
$\text{Q}_g$	Total Gate Charge	$V_{\text{DS}} = -15\text{V}$ , $I_D = -9\text{A}$ $V_{\text{GS}} = -10\text{V}$		26		nC
$\text{Q}_{\text{gs}}$	Gate-Source Charge			4		nC
$\text{Q}_{\text{gd}}$	Gate-Drain Charge			5		nC
$t_{\text{D}(\text{ON})}$	Turn-On Delay Time	$V_{\text{DD}} = -15\text{V}$ , $I_D = -1\text{A}$ $V_{\text{GS}} = -10\text{V}$ $R_{\text{GEN}} = -6 \text{ ohm}$		5.7		ns
$t_r$	Turn-On Rise Time			10		ns
$t_{\text{D}(\text{OFF})}$	Turn-Off Delay Time			18		ns
$t_f$	Turn-Off Fall Time			5		ns

- a. Repetitive rating, Pulse width limited by junction temperature  $T_{\text{J}(\text{MAX})}=150^\circ\text{C}$ . Ratings are based on low frequency and duty cycles to keep initial  $T_{\text{J}}=25^\circ\text{C}$
- b. The power dissipation  $P_{\text{D}}$  is based on  $T_{\text{J}(\text{MAX})}=150^\circ\text{C}$ , using  $\leq 10\text{s}$  junction-to-ambient thermal resistance.
- c. The value of  $R_{\theta_{\text{JA}}}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ . The value in any given application depends on the user's specific board design.
- d. The  $R_{\theta_{\text{JA}}}$  is the sum of the thermal impedance from junction to lead  $R_{\theta_{\text{JL}}}$  and lead to ambient.

## SOP-8 Package Outline



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
<b>A</b>	1.350	1.750	0.053	0.069
<b>A1</b>	0.100	0.250	0.004	0.010
<b>A2</b>	1.350	1.550	0.053	0.061
<b>b</b>	0.330	0.510	0.013	0.020
<b>c</b>	0.170	0.250	0.006	0.010
<b>D</b>	4.700	5.100	0.185	0.200
<b>E</b>	3.800	4.000	0.150	0.157
<b>E1</b>	5.800	6.200	0.228	0.244
<b>e</b>	1.270(BSC)		0.050(BSC)	
<b>L</b>	0.400	1.270	0.016	0.050
<b>θ</b>	0°	8°	0°	8°

单击下面可查看定价，库存，交付和生命周期等信息

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